| ABBOCIATION CONNECTING<br>ELECTRONICS INDUSTRIES® INTERNATIONAL AND PARTICLES | C, Bannock  | burn, Illinois. A         | ll rights reserved un ntions. | nder both   | This docume<br>level parts, t | ent is a decla<br>the declaratio                                 | ration of the s<br>n encompass | substances<br>es all lowe | within the m<br>r level materi | anufacturer<br>ials for whic    | listed item<br>the manu         | Note: if t<br>facturer h  | the item is an ass<br>has engineering i | sembly with lower<br>responsibility. |  |
|---|---|---------------------------|-------------------------------|-------------|-------------------------------|--|--------------------------------|---------------------------|--------------------------------|---------------------------------|---------------------------------|---------------------------|---|--------------------------------------|--|
|   | IPC Web Site for Information on IPC-1752 Standard Form Type<br>http://www.ipc.org/IPC-175x Distribute |                           |                               |             | e *                           | Declaration Class *<br>Class 6 - RoHS Yes/No, Homogeneous Materi |                                |                           |                                |                                 | als and Mfg Information         |                           |   |                                      |  |
| Supplier Information  |   |                           |                               |             |                               |  |                                |                           |                                |                                 |                                 |                           |   |                                      |  |
| Company name* Co  |   |                           | Company unique ID             |             |                               | Unique ID Authority  |                                |                           |                                |                                 | Response Date*                  |                           |   |                                      |  |
| onsemi  |   |                           |                               |             |                               |  |                                |                           |                                |                                 | 2025-09-07                      |                           |   |                                      |  |
| Contact Name Title - Cont   |   |                           | ntact !                       |             |                               | Phone - Contact*   |                                |                           |                                | E                               | Email - Contact*                |                           |   |                                      |  |
| Product-Env-Stewards Pro  |   |                           | Product Enviro Compliance     |             |                               | NA   |                                |                           |                                | I                               | Product-Env-Stewards@onsemi.com |                           |   |                                      |  |
| Authorized Representative* Title  |   |                           | Title - Representative        |             |                               | Phone - Representative*  |                                |                           |                                | E                               | Email - Representative*         |                           |   |                                      |  |
| Product-Env-Stewards  | Product Envi  | Product Enviro Compliance |                               |             | NA                            |  |                                |                           | I                              | Product-Env-Stewards@onsemi.com |                                 |                           |   |                                      |  |
| Requester Item Number   | Mfr Iter  | n Number                  | Mfr Item Name                 |             |                               | Effective D  | ate Version                    | n l                       | Manufacturing Site             |                                 | Wei                             | ght*                      | UOM                                     | Unit Type                            |  |
|   | NLV74<br>G  | HC541ADTR2                | OCTAL 3-STATE NONINVERTIN     |             | TIN                           | 2025-09-07   |                                | ]                         | PH1                            |                                 | 69.2                            | 8                         | mg                                      | Each                                 |  |
| Manufacturing Proccess Informat   | ion   |                           |                               |             |                               | •  |                                | ·                         |                                |                                 |                                 |                           |   |                                      |  |
| Terminal Plating / Grid Array Ma  | terial  | Terminal Base Alloy       |                               | -STD-020 MS | SL Rating Pea                 |  | A Process Body Temperature Max |                           | re Max Tim                     | lax Time at Peak Temperature    |                                 | e Number of Reflow Cycles |   |                                      |  |
| Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)                                   |   | CU Alloy 1                |                               |             |                               | 260  |                                | C 30                      |                                | 30 seco                         |                                 | conds 3                   |   |                                      |  |
| Comments  |   |                           |                               |             |                               |  |                                |                           |                                |                                 |                                 |                           |   |                                      |  |
| evel 1 - maximum time at peak temperatu                                       | re during so  | oldering is 10-3          | 0 seconds                     |             |                               |  |                                |                           |                                |                                 |                                 |                           |   |                                      |  |
| or more information regarding material  | composition   | please refer to           | page 3                        |             |                               |  |                                |                           |                                |                                 |                                 |                           |   |                                      |  |

| RoHS Material Composition Declaration  |  |  |   | Declaration Type *                              | Detailed  |  |  |  |  |  |  |  |
|--|--|--|---|---|---|--|--|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  | RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP). |  |   |   |   |  |  |  |  |  |  |  |
| cadmium, hexavalentchromium, polybrominate<br>contains a RoHS restricted substance inexcess<br>encompass all such components. Supplier certif<br>as of the date that Supplier completes this form<br>Company acknowledges that Supplier may hav<br>independently verified information provided by<br>certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip<br>of an applicable quantity limit, please ir<br>ies that it gathered the information it pro-<br>.Supplier acknowledges that Company<br>e relied on informationprovided by othe<br>y others, Supplier agrees that, at a minin<br>and the Supplier enter into a written agre<br>pource of the Supplier's liability and the   | henyl ethers (each a "<br>ndicate below which, i<br>ovides in this form us<br>will rely on this certifiers<br>in completing this<br>num, itssuppliers have<br>eement with respect to<br>Company's remedies | RoHS restricted substance") in exce<br>if any, RoHS exemption you believe<br>ing appropriate methods to ensure if<br>ication in determining the complian<br>form, and that Supplier may not have<br>e provided certifications regarding the<br>to the identified part, the terms and cc<br>for issues that arise regarding inform | ce of its products with European Union membe    | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |  |  |  |  |  |  |  |
| RoHS Declaration * 1 - Item(s)   | does not contain RoHS restricted substa  | on above   | Supplier Acceptance   | * Accepted                                      |   |  |  |  |  |  |  |  |
| Exemption: If the declared item does not con applicable exemptions.  | ntain RoHS restricted substances per   | the definition above   | except for defined RoHS exempti   | ons, then select the corresponding response i   | n the RoHS Declaration above and choose all   |  |  |  |  |  |  |  |
| Exemption List Version   | EL-2011/534/EU   |  |   |   |   |  |  |  |  |  |  |  |
| Declaration Signature  |  |  |   |   |   |  |  |  |  |  |  |  |
| Instructions: Complete all of the required fin<br>Requester) and click on Submit Form to have  | elds on all pages of this form. Select the form returned to the Requester  | he "Accepted" on th  | e Supplier Acceptance drop-down   | . This will display the signature area. Digital | lly sign the declaration (if required by the  |  |  |  |  |  |  |  |
| Supplier Digital Signature Ra  | stislav Drska  | Le   |   |   |   |  |  |  |  |  |  |  |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| sigma range of distribution unless otherwise noted). |        |                 |          |                         |                  |        |        |                 |  |
|--|--------|-----------------|----------|-------------------------|------------------|--------|--------|-----------------|--|
| Homogeneous Material                                 | Weight | Unit of Measure | Level    | Substance               | CAS              | Exempt | Weight | Unit of Measure |  |
| Die  | 0.29   | mg              | Supplier | Silicon (Si)            | 7440-21-3        |        | 0.29   | mg              |  |
| Die Attach   | 2.46   | mg              |          | Epoxy resin             | proprietary data |        | 0.246  | mg              |  |
|  |        |                 | Supplier | Silver (Ag)             | 7440-22-4        |        | 1.968  | mg              |  |
|  |        |                 | Supplier | Formaldehyde Polymer    | 9003-36-5        |        | 0.246  | mg              |  |
| Lead Frame   | 38.58  | mg              | Supplier | Iron (Fe)               | 7439-89-6        |        | 0.733  | mg              |  |
|  |        |                 | Supplier | Copper (Cu)             | 7440-50-8        |        | 37.847 | mg              |  |
| Mold Compound-Black 2                                | 24.35  | mg              |          | Epoxy resin             | proprietary data |        | 1.2175 | mg              |  |
|  |        |                 | Supplier | Phenol Resin            | Proprietary Data |        | 0.974  | mg              |  |
|  |        |                 | Supplier | Silica Amorphous (SiO2) | 7631-86-9        |        | 2.435  | mg              |  |
|  |        |                 | Supplier | Carbon Black (C)        | 1333-86-4        |        | 0.2435 | mg              |  |
|  |        |                 | Supplier | Fused Silica (SiO2)     | 60676-86-0       |        | 19.48  | mg              |  |
| Plating  | 3.44   | mg              | Supplier | Palladium (Pd)          | 7440-05-3        |        | 0.2614 | mg              |  |
|  |        |                 | В        | Nickel (Ni)             | 7440-02-0        |        | 3.1304 | mg              |  |
|  |        |                 | Supplier | Gold (Au)               | 7440-57-5        |        | 0.0482 | mg              |  |
| Wire Bond - Cu                                       | 0.16   | mg              | Supplier | Copper (Cu)             | 7440-50-8        |        | 0.16   | mg              |  |

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).